

C1206X471JDGACTU

Aliases (C1206X471JDGAC7800) SMD Comm COG HV Flex, Ceramic, 470 pF, 5%, 1,000 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	42 mg
Shelf Life	78 Weeks
MSL	1

ensions		Specificat
Size	1206	Capacitan
	3.3mm +/-0.4mm	Measurem
	1.6mm +/-0.35mm	Tolerance
	1.6mm +/-0.25mm	Voltage DO
	1.5mm MIN	Dielectric \
	0.6mm +/-0.25mm	Temperatu
		Temp. Coe

Packaging Specifications	
Packaging	T&R, 180m
Packaging Quantity	2000

Dime Chip L W T S B

> T&R, 180mm, Plastic Tape 2000

Specifications	
Capacitance	470 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1,200 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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